# **ULTRA LOW CAPACITANCE - SUPER SPEED BUS PROTECTION - TVS ARRAY**



### **DESCRIPTION**

The PSSB05P is an ultra low capacitance transient voltage suppressor array, designed to protect super speed bus applications such as USB 3.0, HDMI1.4 and eSATA from the damaging effects of Electrostatic Discharge and Electrical Fast Transients.

The PSSB05P meets IEC 61000-4-2 (ESD) and IEC 61000-4-4 (EFT) requirements. At higher operating frequencies or faster edge rates, insertion loss and signal integrity are a major concern. This device offers an ultra low capacitance and low leakage current in a miniature DFN-2-0402 package.

### **FEATURES**

- Compatible with IEC 61000-4-2 (ESD): Air(Level 2) 6kV, Contact(Level 3) 6kV
- Compatible with IEC 61000-4-4 (EFT)
- Compatible with IEC 61000-4-5 (Surge)
- 20 Watts Peak Pulse Power per Line (tp = 8/20μs)
- ESD Protection
- · Low Clamping Voltage
- · Protects One Bidirectional Line
- Ultra Low Capacitance: 0.3 pF Typical
- RoHS Compliant
- REACH Compliant

### **MECHANICAL CHARACTERISTICS**

- Molded JEDEC DFN-2-0402 Package
- Approximate Weight: 2 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:

Pure-Tin - Sn, 100: 260-270°C

- 8mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

### **APPLICATIONS**

- USB 3.0 Interface
- HDMI 1.4
- Gigabit Ethernet
- eSATA

## **PIN CONFIGURATION**

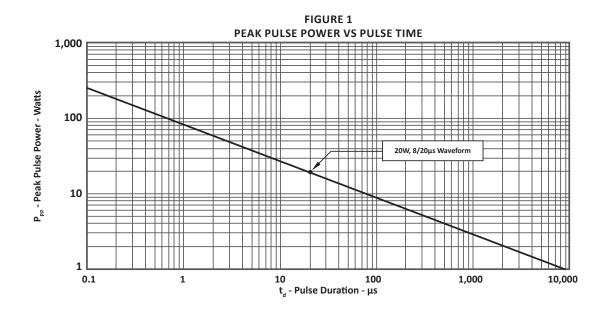


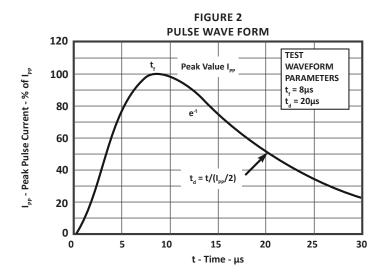
# TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified							
PARAMETER SYMBOL VALUE UNITS							
Peak Pulse Power (tp = 8/20μs) - See Figure 1	P <sub>pp</sub>	20	Watts				
Operating Temperature	T <sub>A</sub>	-55 to 150	°C				
Storage Temperature	T <sub>stg</sub>	-55 to 150	°C				

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified									
PART NUMBER	DEVICE MARKING	RATED STAND-OFF VOLTAGE	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (Fig. 2)	MAXIMUM LEAKAGE CURRENT	TYPICAL CAPACITANCE			
		V <sub>wм</sub> VOLTS	@ 1mA V <sub>(BR)</sub> VOLTS	@I <sub>p</sub> = 1A V <sub>c</sub> VOLTS	@V <sub>wм</sub> Ι <sub>D</sub> μΑ	@0V, 1MHz C <sub>,</sub> pF			
PSSB05P	S	5.0	6.0	20	1	0.3			

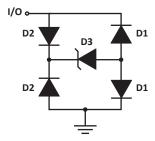
# **TYPICAL DEVICE CHARACTERISTICS**





# **SPICE MODEL**

### FIGURE 1 SPICE MODEL

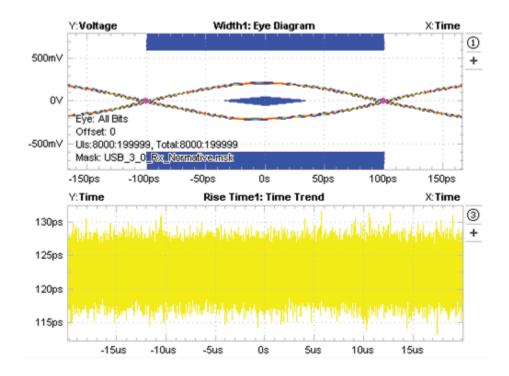


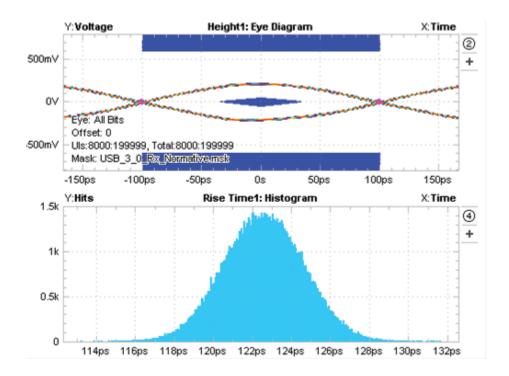
ABD (D3) - Avalanche Breakdown Diode (TVS) LCRD (D1/D2): Low Capacitance Rectifier Diode

TABLE 1 - SPICE PARAMETERS								
PARAMETER	UNIT	ABD/TVS(D3)	LCRD (D1)	LCRD (D2)				
BV	V	11.50	100	100				
IBV	mA	1	1	1				
C <sub>jo</sub>	pF	60	0.3	0.3				
I <sub>s</sub>	А	1E-11	1E-11	1E-11				
Vj	V	0.6	0.6	0.6				
М	-	0.4	0.01	0.01				
N	-	1.1	1.1	1.1				
$R_s$	Ohms	2.9	1.7	1.7				
TT	S	1E-9	1E-9	1E-9				
EG	eV	1.11	1.11	1.11				

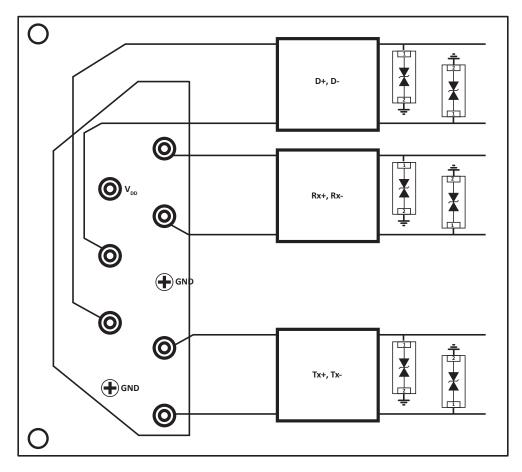
## **TYPICAL DEVICE CHARACTERISTICS**

FIGURE 3 EYE DIAGRAM - USB 3.0





## **APPLICATION INFORMATION**



## **FIGURE 1 - USB 3.0 PROTECTION**

Six PSSB05P devices placed right at the entry point of the connector or at the individual transmission traces. The PSSB05P provides dedicated ESD protection for each super high speed line for the USB interface. PCB traces are not constrained by the protection devices and can be routed in a manner that best suits the design. These devices can also provide protection for USB 2.0 applications.

# **CIRCUIT BOARD RECOMMENDATIONS**

Circuit board layout is critical for electromagnetic compatibility protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

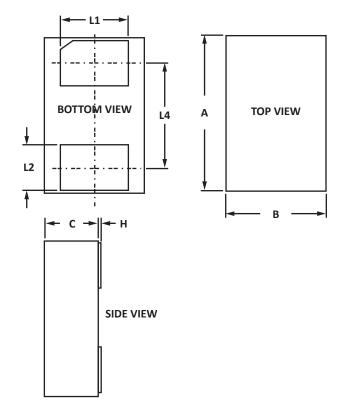


# **DFN-2-0402 PACKAGE INFORMATION**

OUTLINE DIMENSIONS								
DIM	MILLIN	IETERS	INCHES					
	MIN	MAX	MIN	MAX				
А	0.90	1.05	0.035	0.041				
В	0.51	0.65	0.02	0.024				
С	0.51	0.60	0.02	0.024				
Н	0~0.10	0~0.10	0~0.004	0~0.004				
L1	0.45	0.55	0.018	0.022				
L2	0.18	0.30	0.007	0.012				
L4	0.65	BSC	0.026	5 BSC				

### NOTES

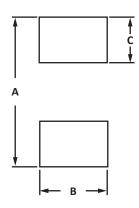
- 1. Dimensioning and tolerances per ANSI Y14.M, 1985.
- 2. Controlling dimension: inches.
- 3. Dimensions are exclusive of mold flash and metal burrs.



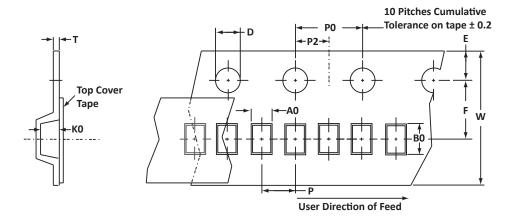
PAD LAYOUT DIMENSIONS								
DINA	MILLIN	IETERS INCHES						
DIM	MIN	MAX	MIN	MAX				
А	1.30	1.50	0.051	0.059				
В	0.60	0.70	0.024	0.028				
С	0.40	0.55	0.016	0.022				
NOTES								

## NOTES

1. Controlling dimension: inches.



# **TAPE AND REEL**



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	W	P0	P2	Р	tmax
178mm (7")	8mm	0.70 ± 0.05	1.15 ± 0.10	0.56 ± 0.05	1.55 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	2.00 ± 0.05	0.25

### NOTES

- 1. Dimensions are in millimeters.
- 2. Surface mount product is taped and reeled in accordance with EIA-481.
- 3. Suffix T710 = 7" Reel 10,000 pieces per 8mm tape.
- 4. Marking on Part marking code (see page 2).

Package outline, pad layout and tape specifications per document number 06094.R1 3/11 - Option 2.

ORDERING INFORMATION								
BASE PART NUMBER LEADFREE SUFFIX TAPE SUFFIX QTY/REEL REEL SIZE TUBE Q								
PSSB05P	n/a	-T710	10,000	7"	n/a			
This device is only available in a Lead-Free configuration.								

05336.R1 10/12 Page 8 ISO 9001: 2015 CERTIFIED



### **COMPANY INFORMATION**

#### **COMPANY PROFILE**

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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